

ABSTRACT

A coil bobbin (10) has a housing (12) having a floor (14) with at least one electrical lead-in
5 (16) projecting therethrough for attachment to a printed circuit board (18). The at least one
electrical lead-in (16) is provided with thermal-strain relief (20) between said floor (14) and
the printed circuit board (18). In a preferred embodiment of the invention the strain relief
takes the form of a loop formed in the lead-in.